## FEATURES

- Integrated NV SRAM, real time clock, crystal, powerfail control circuit and lithium energy source
- Clock registers are accessed identical to the static RAM. These registers are resident in the eight top RAM locations.
- Century byte register
- Totally nonvolatile with over 10 years of operation in the absence of power
- BCD coded century, year, month, date, day, hours, minutes, and seconds with automatic leap year compensation valid up to the year 2100
- Battery voltage level indicator flag
- Power-fail write protection allows for $\pm 10 \% \mathrm{~V}_{\mathrm{CC}}$ power supply tolerance
- Lithium energy source is electrically disconnected to retain freshness until power is applied for the first time
- Standard JEDEC bytewide $2 \mathrm{~K} \times 8$ static RAM pinout
- Quartz accuracy $\pm 1$ minute a month @ $25^{\circ} \mathrm{C}$, factory calibrated

ORDERING INFORMATION

| DS1742-XXX (5 Volt) |  |
| :---: | :---: |
| $\longrightarrow$ | -70 70 ns access |
|  | -100 100 ns access |
| DS1742W-XXX (3.3 Volt) |  |
|  | - -120 120 ns access |
|  | -150 150 ns access |

## DESCRIPTION

The DS1742 is a full function, year 2000 compliant (Y2KC), real-time clock/calendar (RTC) and $2 \mathrm{~K} \times 8$ non-volatile static RAM. User access to all registers within the DS1742 is accomplished with a bytewide interface as shown in Figure 1. The Real Time Clock (RTC) information and control bits reside in the eight uppermost RAM locations. The RTC registers contain century, year, month, date, day, hours, minutes, and seconds data in 24 hour BCD format. Corrections for the day of the month and leap year are made automatically.

## PIN ASSIGNMENT



## PIN DESCRIPTION

| $\mathrm{A} 0-\mathrm{A} 10$ | - Address Inputs |
| :--- | :--- |
| $\overline{\mathrm{CE}}$ | - Chip Enable |
| $\overline{\mathrm{OE}}$ | - Output Enable |
| $\overline{\mathrm{WE}}$ | - Write Enable |
| $\mathrm{V}_{\mathrm{CC}}$ | - Power Supply Input |
| GND | - Ground |
| $\mathrm{DQ} 0-\mathrm{DQ} 7$ | - Data Input/Outputs |

The RTC clock registers are double buffered to avoid access of incorrect data that can occur during clock update cycles. The double buffered system also prevents time loss as the timekeeping countdown continues unabated by access to time register data. The DS1742 also contains its own power-fail circuitry which deselects the device when the $\mathrm{V}_{\mathrm{CC}}$ supply is in an out of tolerance condition. This feature prevents loss of data from unpredictable system operation brought on by low $\mathrm{V}_{\mathrm{CC}}$ as errant access and update cycles are avoided.

## CLOCK OPERATIONS-READING THE <br> CLOCK

While the double buffered register structure reduces the chance of reading incorrect data, internal updates to the DS1742 clock registers should be halted before clock data is read to prevent reading of data in transition. However, halting the internal clock register updating process does not affect clock accuracy. Updating is halted when a one is written into the read bit, bit 6 of the century register, see Table 2. As long as a one remains
in that position, updating is halted. After a halt is issued, the registers reflect the count, that is day, date, and time that was current at the moment the halt command was issued. However, the internal clock registers of the double buffered system continue to update so that the clock accuracy is not affected by the access of data. All of the DS1742 registers are updated simultaneously after the internal clock register updating process has been re-enabled. Updating is within a second after the read bit is written to zero.

## DS1742 BLOCK DIAGRAM Figure 1



DS1742 TRUTH TABLE Table 1

| $\mathrm{V}_{\mathbf{C C}}$ | $\overline{\mathbf{C E}}$ | $\overline{\mathbf{O E}}$ | $\overline{\mathrm{WE}}$ | MODE | DQ | POWER |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| In Tolerance | $\mathrm{V}_{\mathrm{IH}}$ | X | X | DESELECT | HIGH-Z | STANDBY |
|  | $\mathrm{V}_{\mathrm{IL}}$ | X | $\mathrm{V}_{\mathrm{IL}}$ | WRITE | DATA IN | ACTIVE |
|  | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IH}}$ | READ | DATA OUT | ACTIVE |
|  | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{IH}}$ | READ | HIGH-Z | ACTIVE |
|  | X | X | X | DESELECT | HIGH-Z | CMOS STANDBY |
| $<\mathrm{V}_{\text {BAT }}$ | X | X | X | DESELECT | HIGH-Z | DATA RETENTION <br> MODE |

## SETTING THE CLOCK

As shown in Table 2, bit 7 of the century register is the write bit. Setting the write bit to a one, like the read bit, halts updates to the DS1742 registers. The user can then load them with the correct day, date and time data
in 24 hour BCD format. Resetting the write bit to a zero then transfers those values to the actual clock counters and allows normal operation to resume.

## STOPPING AND STARTING THE CLOCK

 OSCILLATORThe clock oscillator may be stopped at any time. To increase the shelf life, the oscillator can be turned off to minimize current drain from the battery. The $\overline{\text { OSC }}$ bit is the MSB (bit 7) of the seconds registers, see Table 2. Setting it to a one stops the oscillator.

## FREQUENCY TEST BIT

As shown in Table 2, bit 6 of the day byte is the frequency test bit. When the frequency test bit is set to logic " 1 " and the oscillator is running, the LSB of the seconds register will toggle at 512 Hz . When the seconds register is being read, the DQ0 line will toggle at the 512 Hz frequency
as long as conditions for access remain valid (i.e., CE low, $\overline{O E}$ low, $\overline{W E}$ high, and address for seconds register remain valid and stable).

## CLOCK ACCURACY

The DS1742 is guaranteed to keep time accuracy to within $\pm 1$ minute per month at $25^{\circ} \mathrm{C}$. The clock is calibrated at the factory by Dallas Semiconductor using special calibration nonvolatile tuning elements. The DS1742 does not require additional calibration and temperature deviations will have a negligible effect in most applications. For this reason, methods of field clock calibration are not available and not necessary.

## DS1742 REGISTER MAP Table 2

| ADDRESS | DATA |  |  |  |  |  |  |  | FUNCTION/RANGE |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADDRESS | $\mathrm{B}_{7}$ | $\mathrm{B}_{6}$ | $\mathrm{B}_{5}$ | $\mathrm{B}_{4}$ | $\mathrm{B}_{3}$ | $\mathrm{B}_{2}$ | $\mathrm{B}_{1}$ | $\mathrm{B}_{0}$ |  |  |
| 7FF | 10 YEAR |  |  |  | YEAR |  |  |  | YEAR | 00-99 |
| 7FE | X | X | X | 10 MO | MONTH |  |  |  | MONTH | 01-12 |
| 7FD | X | X | 10 DATE |  | DATE |  |  |  | DATE | 01-31 |
| 7FC | BF | FT | X | X | X |  | DAY |  | DAY | 01-07 |
| 7FB | X | X | 10 HOUR |  | HOUR |  |  |  | HOUR | 00-23 |
| 7FA | X | 10 MINUTES |  |  |  |  | ES |  | MINUTES | 00-59 |
| 7F9 | OSC | 10 SECONDS |  |  |  | SEC | NDS |  | SECONDS | 00-59 |
| 7F8 | W | R | 10 C | NTURY |  | CEN | JRY |  | CENTURY | 00-39 |
| $\overline{\mathrm{OSC}}=$ STOP BIT$\mathrm{W}=$ WRITE BIT |  | $\begin{aligned} & \mathrm{R}= \\ & \mathrm{X}= \end{aligned}$ |  |  | READ BIT SEE NOTE BELOW |  |  | $\begin{aligned} & \hline \mathrm{FT}=\mathrm{FREQUENCY} \text { TEST } \\ & \mathrm{BF}=\mathrm{BATTERY} \mathrm{FLAG} \end{aligned}$ |  |  |

## NOTE:

All indicated "X" bits are not dedicated to any particular function and can be used as normal RAM bits.

## RETRIEVING DATA FROM RAM OR CLOCK

The DS1742 is in the read mode whenever $\overline{\mathrm{OE}}$ (output enable) is low, $\overline{W E}$ (write enable) is high, and $\overline{C E}$ (chip enable) is low. The device architecture allows ripplethrough access to any of the address locations in the NV SRAM. Valid data will be available at the DQ pins within $t_{\mathrm{AA}}$ after the last address input is stable, providing that the $\overline{\mathrm{CE}}$, and $\overline{\mathrm{OE}}$ access times and states are satisfied. If $\overline{\mathrm{CE}}$, or $\overline{\mathrm{OE}}$ access times and states are not met, valid data will be available at the latter of chip enable access ( $\mathrm{t}_{\text {CEA }}$ ) or at output enable access time ( $\mathrm{t}_{\mathrm{OEA}}$ ). The state of the data input/output pins (DQ) is controlled by $\overline{\mathrm{CE}}$, and $\overline{O E}$. If the outputs are activated before $t_{A A}$, the data lines are driven to an intermediate state until $t_{A A}$. If the
address inputs are changed while $\overline{\mathrm{CE}}$, and $\overline{\mathrm{OE}}$ remain valid, output data will remain valid for output data hold time ( $\mathrm{t}_{\mathrm{OH}}$ ) but will then go indeterminate until the next address access.

## WRITING DATA TO RAM OR CLOCK

The DS1742 is in the write mode whenever $\overline{W E}$, and $\overline{C E}$ are in their active state. The start of a write is referenced to the latter occurring transition of $\overline{W E}$, on $\overline{\mathrm{CE}}$. The addresses must be held valid throughout the cycle. $\overline{\mathrm{CE}}$, or WE must return inactive for a minimum of $t_{\text {WR }}$ prior to the initiation of another read or write cycle. Data in must be valid $t_{D S}$ prior to the end of write and remain valid for
$t_{D H}$ afterward. In a typical application, the $\overline{\mathrm{OE}}$ signal will be high during a write cycle. However, $\overline{O E}$ can be active provided that care is taken with the data bus to avoid bus contention. If $\overline{\mathrm{OE}}$ is low prior to $\overline{\mathrm{WE}}$ transitioning low the data bus can become active with read data defined by the address inputs. A low transition on $\overline{\mathrm{WE}}$ will then disable the outputs $t_{W E Z}$ after $\overline{W E}$ goes active.

## DATA RETENTION MODE

The 5 volt device is fully accessible and data can be written or read only when $\mathrm{V}_{\mathrm{C}}$ is greater than $\mathrm{V}_{\mathrm{PF}}$. However, when $\mathrm{V}_{\mathrm{CC}}$ is below the power fail point, $\mathrm{V}_{\mathrm{PF}}$, (point at which write protection occurs) the internal clock registers and SRAM are blocked from any access. When $\mathrm{V}_{\mathrm{CC}}$ falls below the battery switch point $\mathrm{V}_{\mathrm{SO}}$ (battery supply level), device power is switched from the $\mathrm{V}_{\mathrm{CC}}$ pin to the backup battery. RTC operation and SRAM data are maintained from the battery until $\mathrm{V}_{\mathrm{CC}}$ is returned to nominal levels.

The 3.3 volt device is fully accessible and data can be written or read only when $V_{C C}$ is greater than $V_{P F}$. When $\mathrm{V}_{\mathrm{CC}}$ falls below the power fail point, $\mathrm{V}_{\mathrm{PF}}$, access to the device is inhibited. If $V_{P F}$ is less than $V_{B A T}$, the device power is switched from $\mathrm{V}_{\mathrm{CC}}$ to the backup supply ( $\mathrm{V}_{\mathrm{BAT}}$ ) when $V_{C C}$ drops below $V_{P F}$. If $V_{P F}$ is greater than $V_{B A T}$, the device power is switched from $\mathrm{V}_{\mathrm{CC}}$ to the backup supply ( $\mathrm{V}_{\mathrm{BAT}}$ ) when $\mathrm{V}_{\mathrm{CC}}$ drops below $\mathrm{V}_{\mathrm{BAT}}$. RTC operation and SRAM data are maintained from the battery until $V_{C C}$ is returned to nominal levels.

## BATTERY LONGEVITY

The DS1742 has a lithium power source that is designed to provide energy for clock activity, and clock and RAM data retention when the $\mathrm{V}_{\mathrm{CC}}$ supply is not present. The capability of this internal power supply is sufficient to power the DS1742 continuously for the life of the equipment in which it is installed. For specification purposes, the life expectancy is 10 years at $25^{\circ} \mathrm{C}$ with the internal clock oscillator running in the absence of $\mathrm{V}_{\mathrm{CC}}$ power. Each DS1742 is shipped from Dallas Semiconductor with its lithium energy source disconnected, guaranteeing full energy capacity. When $\mathrm{V}_{\mathrm{CC}}$ is first applied at a level greater than $\mathrm{V}_{\mathrm{PF}}$, the lithium energy source is enabled for battery backup operation. Actual life expectancy of the DS1742 will be much longer than 10 years since no lithium battery energy is consumed when $\mathrm{V}_{\mathrm{CC}}$ is present.

## BATTERY MONITOR

The DS1742 constantly monitors the battery voltage of the internal battery. The Battery Flag bit (bit 7) of the day register is used to indicate the voltage level range of the battery. This bit is not writable and should always be a one when read. If a zero is ever present, an exhausted lithium energy source is indicated and both the contents of the RTC and RAM are questionable.

## ABSOLUTE MAXIMUM RATINGS*

Voltage on Any Pin Relative to Ground
-0.3 V to +6.0 V
Operating Temperature
$0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage Temperature
$-20^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Soldering Temperature
$260^{\circ} \mathrm{C}$ for 10 seconds (See Note 7)

* This is a stress rating only and functional operation of the device at the se or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS
$\left(0^{\circ} \mathrm{C}\right.$ to $\left.70^{\circ} \mathrm{C}\right)$

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Logic 1 Voltage All Inputs <br> $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 10 \%$ <br> $\mathrm{~V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 10 \%$ | $\mathrm{~V}_{\mathrm{IH}}$ | 2.2 |  | $\mathrm{~V}_{\mathrm{CC}}+0.3 \mathrm{~V}$ | V | 1 |
|  | $\mathrm{~V}_{\mathrm{IH}}$ | 2.0 |  | $\mathrm{~V}_{\mathrm{CC}}+0.3 \mathrm{~V}$ | V | 1 |
| Logic 0 Voltage All Inputs <br> $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 10 \%$ <br> $\mathrm{~V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 10 \%$ | $\mathrm{~V}_{\mathrm{IL}}$ | -0.3 |  | 0.8 | V | 1 |
|  | $\mathrm{~V}_{\mathrm{IL}}$ | -0.3 |  | 0.6 | V | 1 |

DC ELECTRICAL CHARACTERISTICS
$\left(0^{\circ} \mathrm{C}\right.$ to $\left.70^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 10 \%\right)$

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Active Supply Current | $I_{\text {cc }}$ |  | 15 | 50 | mA | 2, 3 |
| TTL Standby Current $\left(\overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IH}}\right)$ | $\mathrm{I}_{\mathrm{CC} 1}$ |  | 1 | 3 | mA | 2, 3 |
| CMOS Standby Current <br> ( $\mathrm{CE} \geq \mathrm{V}_{\mathrm{CC}}-0.2 \mathrm{~V}$ ) | Icc2 |  | 1 | 3 | mA | 2, 3 |
| Input Leakage Current (any input) | $1 / L$ | -1 |  | +1 | $\mu \mathrm{A}$ |  |
| Output Leakage Current (any output) | loL | -1 |  | +1 | $\mu \mathrm{A}$ |  |
| Output Logic 1 Voltage $\text { (IOUT }=-1.0 \mathrm{~mA})$ | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 |  |  |  | 1 |
| Output Logic 0 Voltage (IOUT $=+2.1 \mathrm{~mA}$ ) | $\mathrm{V}_{\mathrm{OL}}$ |  |  | 0.4 |  | 1 |
| Write Protection Voltage | $V_{\text {PF }}$ | 4.25 | 4.37 | 4.50 | V | 1 |
| Battery Switch Over Voltage | $\mathrm{V}_{\text {So }}$ |  | $\mathrm{V}_{\text {BAT }}$ |  |  | 1, 4 |

DC ELECTRICAL CHARACTERISTICS
$\left(0^{\circ} \mathrm{C}\right.$ to $\left.70^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 10 \%\right)$

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Active Supply Current | Icc |  | 10 | 30 | mA | 2, 3 |
| TTL Standby Current ( $\overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IH}}$ ) | $\mathrm{I}_{\mathrm{CC} 1}$ |  | 0.7 | 2 | mA | 2, 3 |
| CMOS Standby Current ( $\overline{C E} \geq \mathrm{VCC}-0.2 \mathrm{~V}$ ) | $\mathrm{I}_{\text {cc2 }}$ |  | 0.7 | 2 | mA | 2, 3 |
| Input Leakage Current (any input) | $1 / L$ | -1 |  | +1 | $\mu \mathrm{A}$ |  |
| Output Leakage Current (any output) | l O | -1 |  | +1 | $\mu \mathrm{A}$ |  |
| Output Logic 1 Voltage (IOUT $=-1.0 \mathrm{~mA}$ ) | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 |  |  |  | 1 |
| Output Logic 0 Voltage (lout $=2.1 \mathrm{~mA}$ ) | $\mathrm{V}_{\text {OL }}$ |  |  | 0.4 |  | 1 |
| Write Protection Voltage | $\mathrm{V}_{\text {PF }}$ | 2.80 | 3.88 | 2.97 | V | 1 |
| Battery Switch Over Voltage | $\mathrm{V}_{\text {So }}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{BAT}} \text { or } \\ \mathrm{V}_{\mathrm{PF}} \end{gathered}$ |  | V | 1, 4 |

READ CYCLE, AC CHARACTERISTICS
$\left(0^{\circ} \mathrm{C}\right.$ to $\left.70^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 10 \%\right)$

| PARAMETER | SYMBOL | 70 ns access |  | 100 ns access |  | UNITS | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | MAX | MIN | MAX |  |  |
| Read Cycle Time | $\mathrm{t}_{\mathrm{RC}}$ | 70 |  | 100 |  | ns |  |
| Address Access Time | $\mathrm{t}_{\mathrm{AA}}$ |  | 70 |  | 100 | ns |  |
| $\overline{\mathrm{CE}}$ to DQ Low-Z | $\mathrm{t}_{\text {CEL }}$ | 5 |  | 5 |  | ns |  |
| $\overline{\text { CE Access Time }}$ | $\mathrm{t}_{\text {CEA }}$ |  | 70 |  | 100 | ns |  |
| $\overline{\text { CE Data Off Time }}$ | $\mathrm{t}_{\text {cez }}$ |  | 25 |  | 35 | ns |  |
| $\overline{\mathrm{OE}}$ to DQ Low-Z | toel | 5 |  | 5 |  | ns |  |
| $\overline{\text { OE Access Time }}$ | toea |  | 35 |  | 55 | ns |  |
| $\overline{\text { OE Data Off Time }}$ | toez |  | 25 |  | 35 | ns |  |
| Output Hold from Address | $\mathrm{t}_{\mathrm{OH}}$ | 5 |  | 5 |  | ns |  |

READ CYCLE, AC CHARACTERISTICS
$\left(0^{\circ} \mathrm{C}\right.$ to $\left.70^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 10 \%\right)$

| PARAMETER | SYMBOL | 120 ns access |  | 150 ns access |  | UNITS | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | MAX | MIN | MAX |  |  |
| Read Cycle Time | $\mathrm{t}_{\mathrm{RC}}$ | 120 |  | 150 |  | ns |  |
| Address Access Time | $t_{\text {AA }}$ |  | 120 |  | 150 | ns |  |
| $\overline{\text { CE low to DQ Low-Z }}$ | tcel | 5 |  | 5 |  | ns |  |
| $\overline{\text { CE Access Time }}$ | tcea |  | 120 |  | 150 | ns |  |
| $\overline{\text { CE Data Off Time }}$ | $\mathrm{t}_{\text {cez }}$ |  | 40 |  | 50 | ns |  |
| OE Low to DQ Low-Z | toel | 5 |  | 5 |  | ns |  |
| $\overline{\text { OE Access Time }}$ | toea |  | 100 |  | 130 | ns |  |
| $\overline{\text { OE Data Off Time }}$ | toez |  | 35 |  | 35 | ns |  |
| Output Hold from Address | toh | 5 |  | 5 |  | ns |  |

## READ CYCLE TIMING DIAGRAM



WRITE CYCLE, AC CHARACTERISTICS
$\left(0^{\circ} \mathrm{C}\right.$ to $70^{\circ} \mathrm{C}$; $\left.\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 10 \%\right)$

| PARAMETER | SYMBOL | 70 ns access |  | 100 ns access |  | UNITS | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | MAX | MIN | MAX |  |  |
| Write Cycle Time | twc | 70 |  | 100 |  | ns |  |
| Address Setup Time | $t_{\text {AS }}$ | 0 |  | 0 |  | ns |  |
| $\overline{\text { WE Pulse Width }}$ | twew | 50 |  | 70 |  | ns |  |
| $\overline{\text { CE Pulse Width }}$ | ${ }^{\text {t }}$ CEW | 55 |  | 75 |  | ns |  |
| Data Setup Time | $t_{\text {DS }}$ | 30 |  | 40 |  | ns |  |
| Data Hold Time | $\mathrm{t}_{\mathrm{DH}}$ | 0 |  | 0 |  | ns |  |
| Address Hold Time | $\mathrm{t}_{\text {AH }}$ | 0 |  | 0 |  | ns |  |
| $\overline{\text { WE Data Off Time }}$ | $\mathrm{t}_{\text {wez }}$ |  | 25 |  | 35 | ns |  |
| Write Recovery Time | twr | 5 |  | 5 |  | ns |  |

## WRITE CYCLE, AC CHARACTERISTICS

$\left(0^{\circ} \mathrm{C}\right.$ to $\left.70^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 10 \%\right)$

| PARAMETER | SYMBOL | 120 ns access |  | 150 ns access |  | UNITS | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | MAX | MIN | MAX |  |  |
| Write Cycle Time | twc | 120 |  | 150 |  | ns |  |
| Address Setup Time | $\mathrm{t}_{\text {AS }}$ | 0 |  | 0 |  | ns |  |
| WE Pulse Width | twew | 100 |  | 130 |  | ns |  |
| CE Pulse Width | tcew | 110 |  | 140 |  | ns |  |
| Data Setup Time | $t_{\text {DS }}$ | 80 |  | 90 |  | ns |  |
| Data Hold time | $t_{\text {DH }}$ | 0 |  | 0 |  | ns |  |
| Address Hold Time | $\mathrm{t}_{\mathrm{AH}}$ | 0 |  | 0 |  | ns |  |
| $\overline{\text { WE Data Off Time }}$ | twez |  | 40 |  | 50 | ns |  |
| Write Recovery Time | twr | 10 |  | 10 |  | ns |  |

## WRITE CYCLE TIMING DIAGRAM,WRITE ENABLE CONTROLLED



WRITE CYCLE TIMING DIAGRAM, CE, CONTROLLED


POWER-UP/DOWN AC CHARACTERISTICS
$\left(0^{\circ} \mathrm{C}\right.$ to $\left.70^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 10 \%\right)$

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$ at $\mathrm{V}_{\text {IH, }}$, CE2 at $\mathrm{V}_{\text {IL }}$, Before Power-down | tPD | 0 |  |  | $\mu \mathrm{s}$ |  |
| $\mathrm{V}_{\mathrm{CC}}$ Fall Time: $\mathrm{V}_{\mathrm{PF}}(\mathrm{MAX})$ to $\mathrm{V}_{\mathrm{PF}}$ (Min) | $\mathrm{t}_{\mathrm{F}}$ | 300 |  |  | $\mu \mathrm{s}$ |  |
| $\mathrm{V}_{\text {CC }}$ Fall Time: $\mathrm{V}_{\text {PF }}(\mathrm{MIN})$ to $\mathrm{V}_{\text {So }}$ | $\mathrm{t}_{\text {FB }}$ | 10 |  |  | $\mu \mathrm{s}$ |  |
| $\mathrm{V}_{\text {CC }}$ Rise Time: $\mathrm{V}_{\text {PF }}(\mathrm{MIN})$ to $\mathrm{V}_{\text {PF }}$ (MAX) | $\mathrm{t}_{\mathrm{R}}$ | 0 |  |  | $\mu \mathrm{s}$ |  |
| Power-up Recover Time | $t_{\text {REC }}$ |  |  | 35 | ms |  |
| Expected Data Retention Time (Oscillator On) | $t_{\text {DR }}$ | 10 |  |  | years | 5,6 |

## POWER-UP/DOWN WAVEFORM TIMING 5 VOLT DEVICE




POWER-UP/DOWN WAVEFORM TIMING 3.3 VOLT DEVICE


CAPACITANCE
CAPACITANCE

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Capacitance on all input pins | $\mathrm{C}_{\mathrm{IN}}$ |  |  | 7 | pF |  |
| Capacitance on all output pins | $\mathrm{C}_{\mathrm{O}}$ |  |  | 10 | pF |  |

## AC TEST CONDITIONS

## Output Load: $\quad 100 \mathrm{pF}+1 \mathrm{TTL}$ Gate <br> Input Pulse Levels: $\quad 0.0$ to 3.0 Volts

Timing Measurement Reference Levels:
Input: 1.5V
Output: 1.5V
Input Pulse Rise and Fall Times: 5 ns

## NOTES:

1. Voltages are referenced to ground.
2. Typical values are at $25^{\circ} \mathrm{C}$ and nominal supplies.
3. Outputs are open.
4. Battery switch over occurs at the lower of either the battery terminal voltage or $\mathrm{V}_{\mathrm{PF}}$.
5. Data retention time is at $25^{\circ} \mathrm{C}$.
6. Each DS1742 has a built-in switch that disconnects the lithium source until $\mathrm{V}_{\mathrm{CC}}$ is first applied by the user. The expected $t_{D R}$ is defined as a cumulative time in the absence of $V_{C C}$ starting from the time power is first applied by the user.
7. Real-Time Clock Modules can be successfully processed through conventional wave-soldering techniques as long as temperature exposure to the lithium energy source contained within does not exceed $+85^{\circ} \mathrm{C}$. Post solder cleaning with water washing techniques is acceptable, provided that ultrasonic vibration is not used to prevent damage to the crystal.
DS1742 24-PIN PACKAGE


| PKG | 24-PIN |  |
| :---: | :---: | :---: |
| DIM | MIN | MAX |
| $\begin{gathered} \text { A IN. } \\ \text { MM } \end{gathered}$ | $\begin{aligned} & 1.270 \\ & 37.34 \end{aligned}$ | $\begin{aligned} & 1.290 \\ & 37.85 \end{aligned}$ |
| $\begin{aligned} & \mathrm{B} \text { MM. } \mathrm{IN} . \end{aligned}$ | $\begin{aligned} & 0.675 \\ & 17.15 \end{aligned}$ | $\begin{aligned} & 0.700 \\ & 17.78 \end{aligned}$ |
| $C_{\text {MM }} \mathbf{I N} .$ | $\begin{aligned} & 0.315 \\ & 8.00 \end{aligned}$ | $\begin{aligned} & 0.335 \\ & 8.51 \end{aligned}$ |
| $\begin{gathered} \text { D IN. } \\ \text { MM } \end{gathered}$ | $\begin{aligned} & 0.075 \\ & 1.91 \end{aligned}$ | $\begin{aligned} & 0.105 \\ & 2.67 \end{aligned}$ |
| $\mathrm{E}_{\mathrm{MM}}^{\mathrm{IN} .}$ | $\begin{aligned} & 0.015 \\ & 0.38 \end{aligned}$ | $\begin{aligned} & 0.030 \\ & 0.76 \end{aligned}$ |
| $F_{\text {MM }}^{\mathbb{I N} .}$ | $\begin{aligned} & 0.140 \\ & 3.56 \end{aligned}$ | $\begin{aligned} & 0.180 \\ & 4.57 \end{aligned}$ |
| $\mathrm{G}_{\mathrm{MM}}^{\mathrm{IN} .}$ | $\begin{aligned} & 0.090 \\ & 2.29 \end{aligned}$ | $\begin{aligned} & 0.110 \\ & 2.79 \end{aligned}$ |
| $\mathrm{H}_{\mathrm{MM}}^{\mathrm{IN} .}$ | $\begin{aligned} & 0.590 \\ & 14.99 \end{aligned}$ | $\begin{aligned} & 0.630 \\ & 16.00 \end{aligned}$ |
| $\mathrm{J}_{\mathrm{MM}}^{\mathrm{IN} .}$ | $\begin{aligned} & 0.010 \\ & 0.25 \end{aligned}$ | $\begin{aligned} & 0.018 \\ & 0.45 \end{aligned}$ |
| $\begin{aligned} & \mathrm{K}_{\mathrm{MM}}^{\mathrm{IN} .} \end{aligned}$ | $\begin{aligned} & 0.015 \\ & 0.43 \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.025 \\ & 0.58 \end{aligned}$ |



